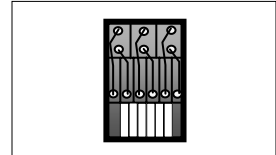
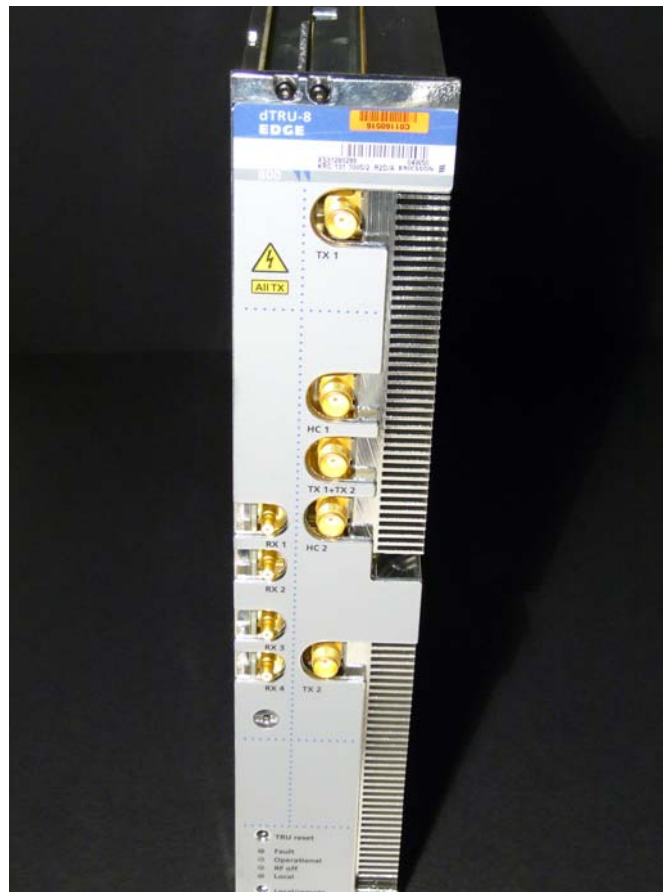


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Ericsson GSM/EDGE 850MHz dTRU Model KRC1311005/2

September 2006



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TABLE OF CONTENTS

EXECUTIVE SUMMARY	5
Active/Passive Component Summary	5
Important Note:	6
CHAPTER 1	7
1.1 Overview of Ericsson Expander RBS and dTRU	7
CHAPTER 2 TRANSCEIVER	12
2.1 Transceiver PCB Layout	12
2.2 Baseband Signal Processing	14
2.3 Power Management	15
2.4 Section A.....	16
2.4.1 PF3S27 4N Hybrid Module	17
2.5 Section B Transmitter.....	18
2.6 Section C Receiver	20
2.6.1 PF3S25 46 Hybrid Module	22
2.7 Section D Switch Matrix.....	23
2.8 Section E Timing Control.....	24
2.9 Section F Hybrid Module	25
2.10 Section G Hybrid Module.....	27
CHAPTER 3 RF HIGH POWER AMPLIFIER	29
3.1 Mechanical Analysis	29
3.2 Power Management	34
3.3 RF Transmitter	35
3.4 Output Stage RF Power Transistor.....	37
APPENDIX A - PASSIVE CASE SIZE ANALYSIS.....	40
APPENDIX B - ACTIVE COMPONENT MARKET SHARE	42

TABLES

Table 1: Transceiver Baseband Signal Processing Section Bill of Materials	14
Table 2: Transceiver Power Management Section Bill of Materials.....	15
Table 3: Transceiver Section A Bill of Materials.....	16
Table 4: PF3S27 4N Hybrid Module Bill of Materials	17
Table 5: Transceiver Section B Bill of Materials.....	18
Table 6: Transceiver Section C Bill of Materials.....	20
Table 7: PF3S25 46 Hybrid Module Bill of Materials	22
Table 8: Transceiver Section D Bill of Materials.....	23
Table 9: Transceiver Section D Bill of Materials.....	24
Table 10: Transceiver Section F R1E RYT9026010/2 R1D Module	25
Table 11: Transceiver Section G R1E RYT9026009/2 R1D Module.....	27
Table 12: RF Power Amplifier 1 Power Supply Section Bill of Materials.....	34
Table 13: RF Power Amplifier 1 RF Transmitter Section Bill of Materials.....	36
Table 14: Active/Passive Component Distribution by System Subsection	41

EXHIBITS

Exhibit 1: Ericsson GSM dTRU Diagram	7
Exhibit 2: Generic GSM Base Station Diagram	8
Exhibit 3: Ericsson GSM dTRU Assembly Diagram (Side View)	9
Exhibit 4: dTRU Transceiver Shield	9
Exhibit 5: dTRU Power Amplifiers	10
Exhibit 6: Transceiver with RF Power Amplifiers Removed	10
Exhibit 7: dTRU Front Panel (Obverse and Reverse) Diagram.....	11
Exhibit 8: dTRU Front Panel/Main Housing Diagram (Side View).....	11
Exhibit 9: 850MHz Transceiver Printed Circuit Board (Front View)	13
Exhibit 10: 850MHz Transceiver Printed Circuit Board (Back View)	13
Exhibit 11: Baseband Signal Processing Component Diagram	14
Exhibit 12: Power Management Component Diagram.....	15
Exhibit 13: Section A Component Diagram.....	16
Exhibit 14: PF3S27 4N Module	17
Exhibit 15: PF3S27 4N Hybrid Module Component Diagram.....	17
Exhibit 16: Section B Component Diagram.....	18
Exhibit 17: dTRU Small Signal Transmit Block Diagram.....	19
Exhibit 18: Section C Component Diagram.....	20
Exhibit 19: IF Rx SAW Filter Close Up	21
Exhibit 20: EPCOS B3625 Input/Output Matching Recommendation.....	21
Exhibit 21: PF3S25 46 Module	22
Exhibit 22: PF3S25 46 Hybrid Module Component Diagram	22
Exhibit 23: Section D Component Diagram	23
Exhibit 24: Section E Component Diagram.....	24
Exhibit 25: R1E RYT9026010/2 R1D Module.....	25
Exhibit 26: R1E RYT9026010/2 R1D Component Diagram (Shielding Intact)	26
Exhibit 27: RYT9026009/2 R1D Module	27
Exhibit 28: RYT9026009/2 R1D Hybrid Module Component Diagram (Shielding Removed)	28
Exhibit 29: RF Power Amplifier 1 Printed Circuit Board (Top View)	29
Exhibit 30: RF Power Amplifier 2 Printed Circuit Board (Top View)	29
Exhibit 31: RF Power Amplifier 1 PCB Top View Diagram.....	30
Exhibit 32: RF Power Amplifier 2 PCB Top View Diagram.....	30
Exhibit 33: RF Power Amplifier 1 Mechanical Side View Diagram	31
Exhibit 34: RF Power Amplifier 2 Mechanical Side View Diagram	31
Exhibit 35: RF Power Amplifier 1 Shield Cover Top View Diagram.....	32
Exhibit 36: RF Power Amplifier 2 Shield Cover Top View Diagram.....	32
Exhibit 37: RF Power Amplifier 1 Shield Cover Bottom View Diagram	33
Exhibit 38: RF Power Amplifier 2 Shield Cover Bottom View Diagram	33
Exhibit 39: RF Power Amplifier 1 Power Supply Component Diagram	35
Exhibit 40: 850MHz GSM/EDGE Power Amplifier Block Diagram	35
Exhibit 41: RF Power Amplifier 1 RF Transmitter Section Component Diagram	36
Exhibit 42: RF Power Transistor	37
Exhibit 43: De-Capped RF Power Transistor	37
Exhibit 44: Electrical Circuit Model for RF Power Transistor.....	38
Exhibit 45: RF Power Transistor Wire Bonding Diagram.....	38
Exhibit 46: RF Transistor Die Type Identification.....	39
Exhibit 47: Close-up Magnification View of Transistor Geometry.....	39

Exhibit 48: Passive Component Case Size Distribution40
Exhibit 49: Active Semiconductor Component Market Share42